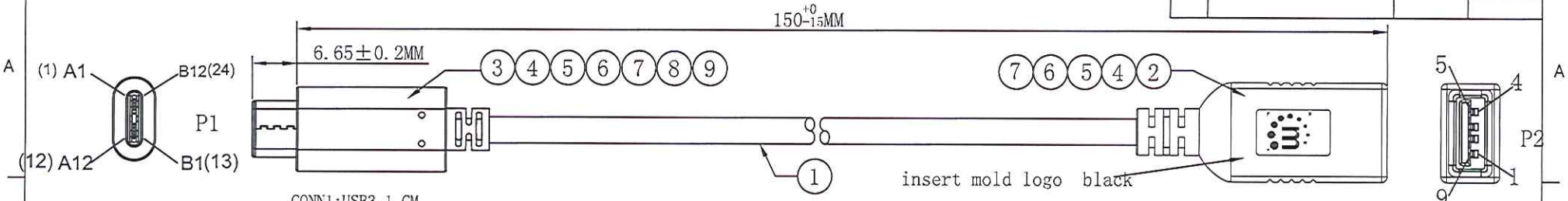
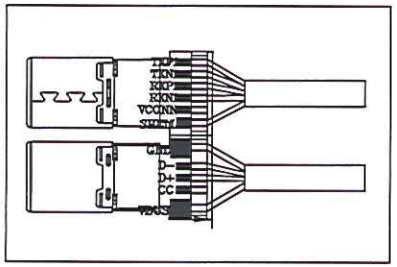
由 Autodesk 教育版产品制作

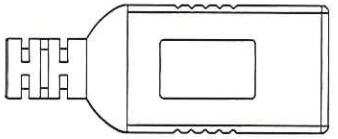
REV.	DESCRIPTION	ENG.	APPROVAL



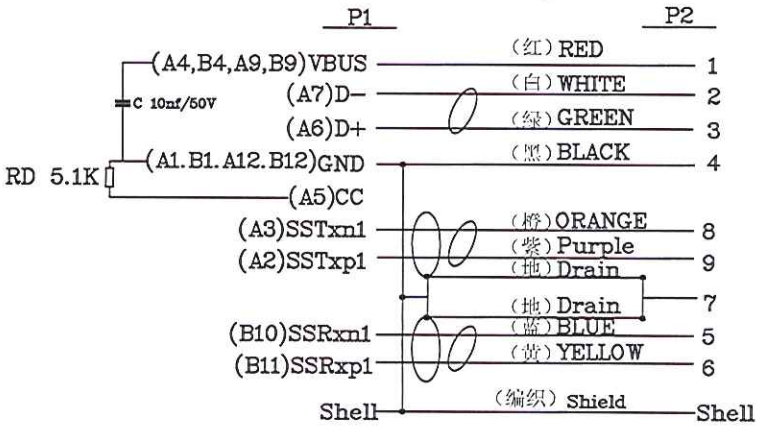
CONN1:USB3.1 CM



CONN2:USB3.0 (A)F



Pin Assignment



Electrical Test:

1. 100%Test(Open ,short ,miss wire)
2. Contact Resistance: 2 ohm max.
3. Insulation Resistance: 100M ohm Min.
4. Hi-Pot: 300VDC/10ms.
5. USB AF :insert mold logo " m"

ok.
Allen
2016.1.27

NO.	DESCRIPTION	Q'TY	UNIT
9	USB 3.0 Clamp the material?PNY-66+15%GF?30+30+24AWG ITEM?9.9*3.5*2.5MM	1	pcs
8	USB TYPE C-SOLDER TYPE-~ Tin Plating Nickel up ~?No riveting claw)	1	pcs
7	USB TYPE C-SOLDER TYPE-~ Tin Plating Nickel Down-~?No riveting claw)	1	pcs
6	H.S.T #2.0 BLACK	1	pcs
5	USB 3.1 C Type male Connector Black insulation Nickel Plated Shell With PCBA (Resistance5.1KΩ)with10n capacitance	1	pcs
4	Outside Molding 45P PVC PMS:Blue	16	g
3	Intside Molding: PE	4	g
2	USB3.0 (A)F SOLDER INSULATION:BLACK SHELL NICKEL PLATED	1	Set
1	[illegible]	0.142	m

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF INTRACOM Asia Co.,Ltd. AND SHALL NOT BE REPRODUCED COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF INTRACOM Asia Co.,Ltd.

UNLESS OTHERWISE SPECIFIED:DIMENSIONS ARE IN MILLIMETERS ANGULAR TOLERANCE:±1°

TOLERANCE(INCH)		TOLERANCE(MM)	
x	±0.02"	x	±0.5mm
x.x	±0.01"	x.x	±0.20mm
x.xx	±0.008"	x.xx	±0.15mm
x.xxx	±0.005"	x.xxx	±0.10mm

INTRACOM 安達康股份有限公司 INTRACOM Asia Co.,LTD.

TITLE: MH USB3.1Gen1 Cbl AM-AF,3A,BLue,15cm	APPD				
	Check				
CUSTOMER:	Drawer	limin		Date	16.01.20
CUSTOMER P/N: 353540	Unit	mm	Projection		
ICT P/N:	Scale	1:1	Size.	A4	
DWG.NO:	Sheet	1 of	REV.	A05	

THIS DRAWING MAY BE USED IN WHOLE OR PART

由 Autodesk 教育版产品制作